

旺矽科技股份有限公司 6223.TT

Presentation Disclaimer

The information herein contains forward-looking statements. We have based these forward-looking statements on our current expectations and projections about future events. Although we believe that these expectations and projections are reasonable, such forward-looking statements are inherently subject to risks, uncertainties and assumptions about us, including, among other things: the intensely competitive Semi-conductor, and LED industries and markets; Cyclical nature of the semiconductor industry; Risks associated with global business activities; General economic and political conditions. All financial figures discussed herein are prepared pursuant to IFRS. All audited figures will be publicly announced upon the completion of our audited process.

MPI 部門概覽



Since 1995

Probe Card



Since 2001

Photonics Automation



Since 2014

Advanced Semiconductor Test



Since 2015

Thermal Test



Since 2021

Celadon Systems

MPI 全球據點



MPI
Locations



MPI America
CA, USA (2017)

Worldwide



MPI Suzhou
Jiangsu, CN (2017)



Celadon Systems
MN, USA (2021)



Headquarters
Hsinchu, TW (2000)



Luzhu Office
Kaohsiung, TW (2006)



2nd Production Site
Hsinchu, TW (2012)



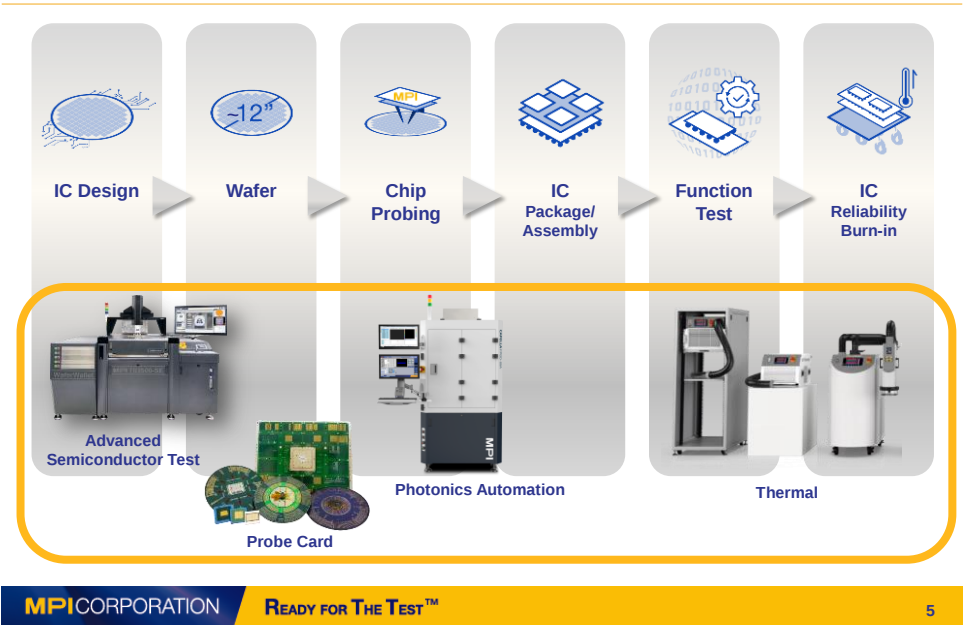
Xingpu Office
Hsinchu, TW (2014)



3rd Production Site
Hsinchu, TW (2021)

Taiwan

MPI-The Powerhouse of Testing Solutions



議程



Business Contents

Probe Card
Photonics Automation
Thermal & AST



Financial Statements

MPICORPORATION

Probe Card

半導體事業部 (探針卡)

READY FOR THE TEST™

MPIProbe Card

Advanced Wafer Sort Test Solutions

Vertical / MEMS

Cantilever



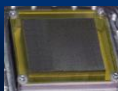
Features



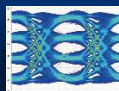
Fine Pitch



MEMS



High Pin Count



High Speed



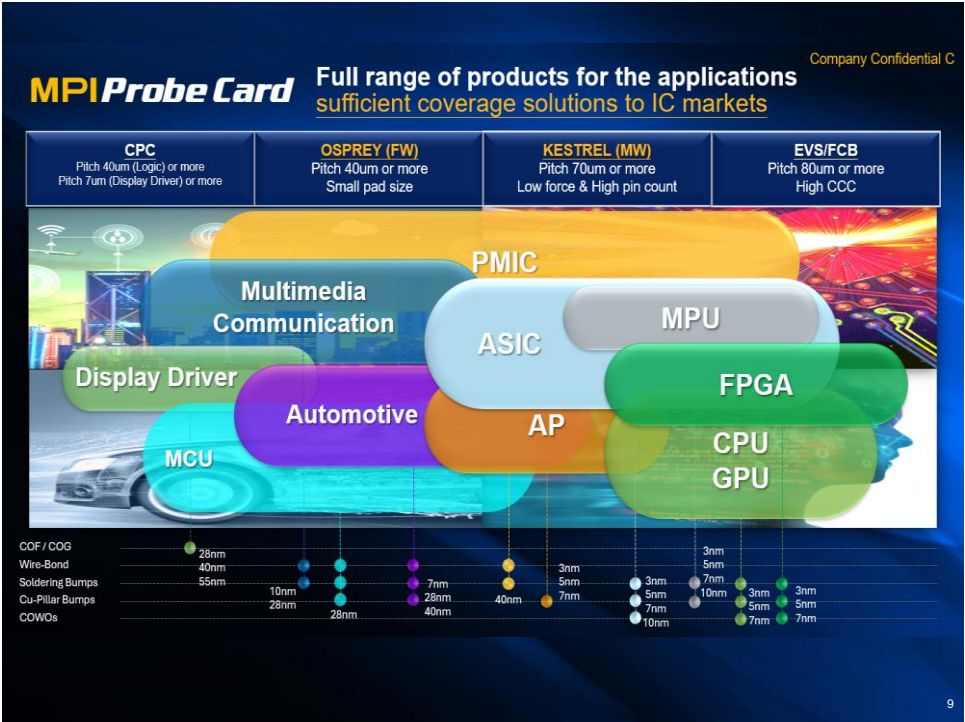
Substrate



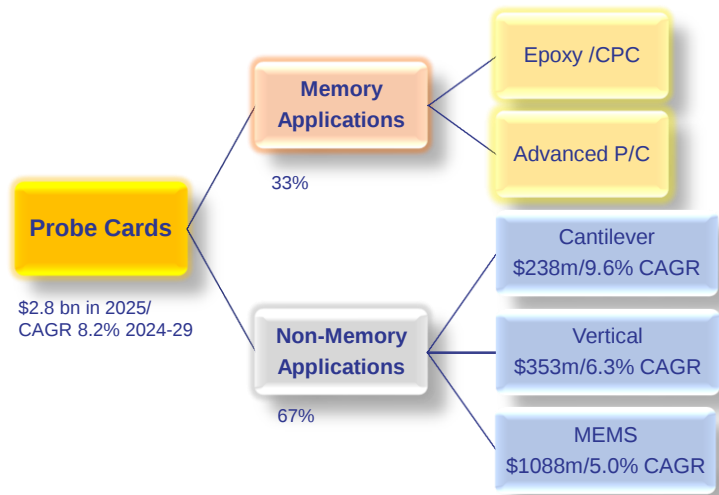
Hand-wired



RF



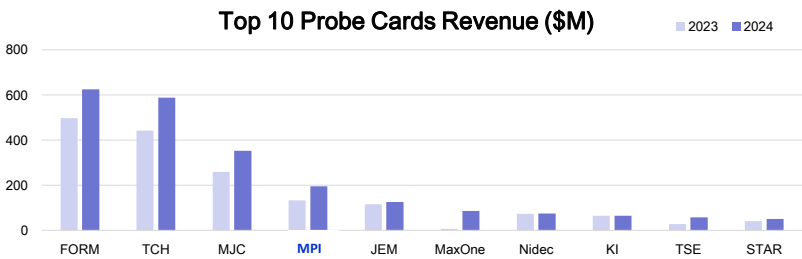
全球探針卡市場



Source: Technisights

自製IC探針卡供應商

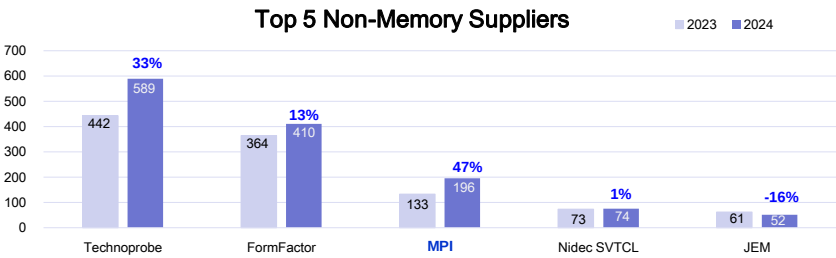
	(Rank)		2020	2021	2022	2023	2024
FormFactor	USA	1	1	1	1	1	1
Technoprobe	Italy	2	2	2	2	2	2
Micronics Japan	Japan	3	3	3	3	3	3
MPI Corporation	Taiwan	5	5	5	4	4	4
Japan Electronic Materials	Japan	4	4	4	5	5	5



Source: TechnInsights

前五大非記憶體探針卡供應商

	(Rank)		2020	2021	2022	2023	2024
Technoprobe	Italy	2	1	1	1	1	1
FormFactor	USA	1	2	2	2	2	2
MPI Corporation	Taiwan	3	3	3	3	3	3
Nidec SV Probe	Singapore	4	5	4	4	4	4
Japan Electronic Materials	Japan	5	4	5	5	5	5



Source: TechnInsights

Probe Card:提供全方位解決方案

- **Comprehensive Product Range for Circuit Testing**

全方位的產品布局

MPI provides omnidirectional products to global customers, including fine pitch CPC, high speed VPC and low force MEMS solutions.

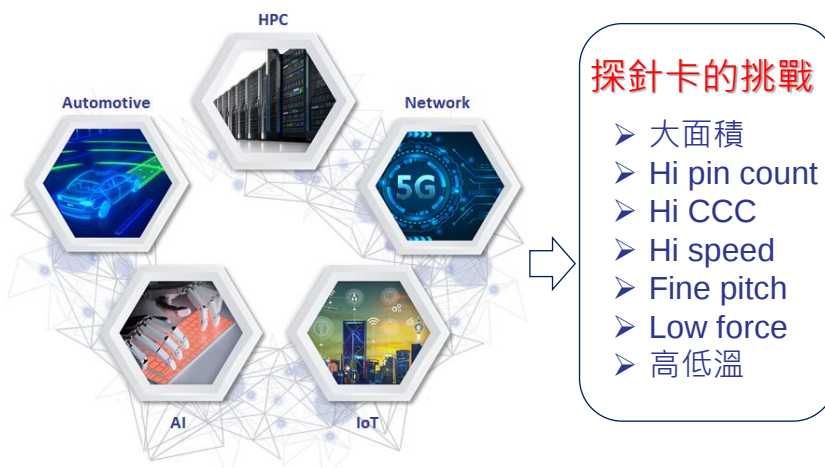
- **Solid Global Clientele** 堅實的國際合作夥伴

MPI works closely with worldwide market leaders, especially for the AI, HPC application related.

- **Complete Probe Card Solution** 完整的探針卡整合方案

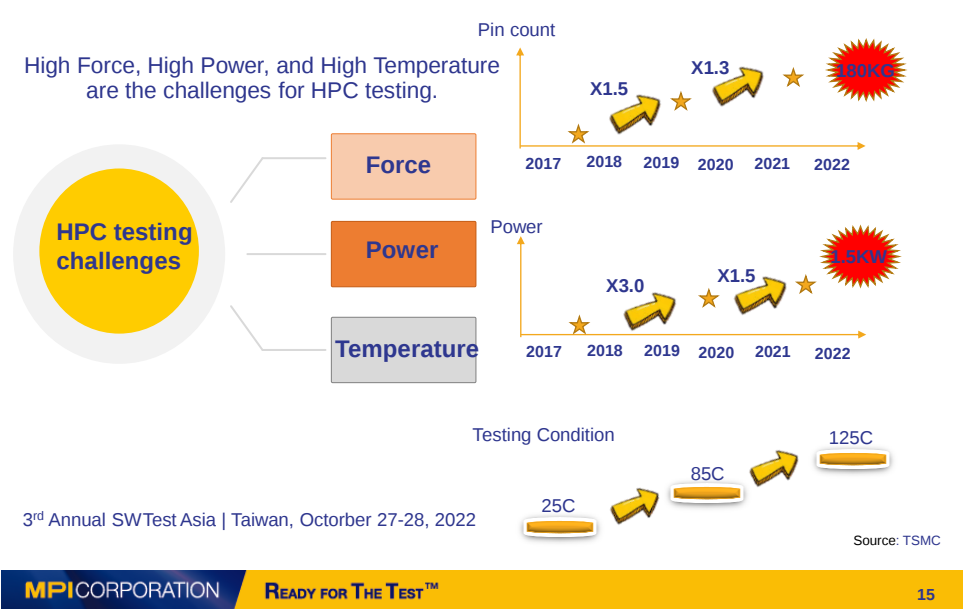
Provide probe head, substrate(MLO/MLC/MLOC) and PCB one-stop service.

快速增長的應用層面



Source: TSMC

HPC挑戰

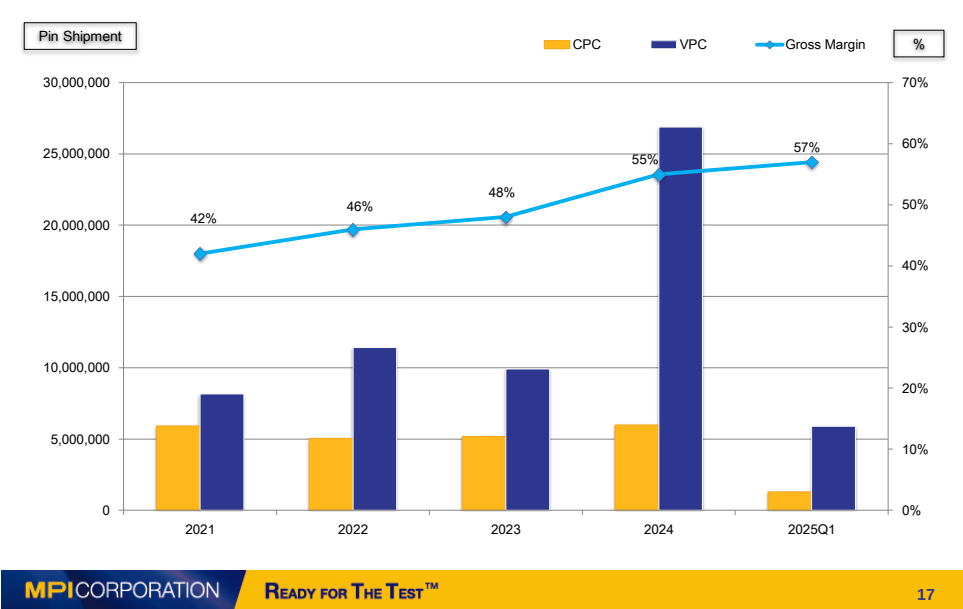


Interface Technical Complexity Check in

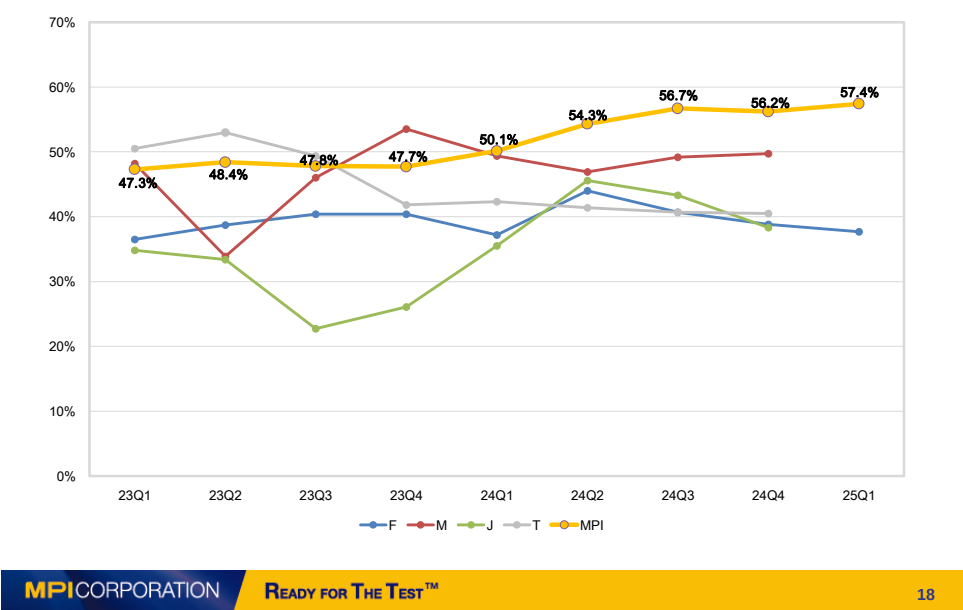


Source:Teradyne

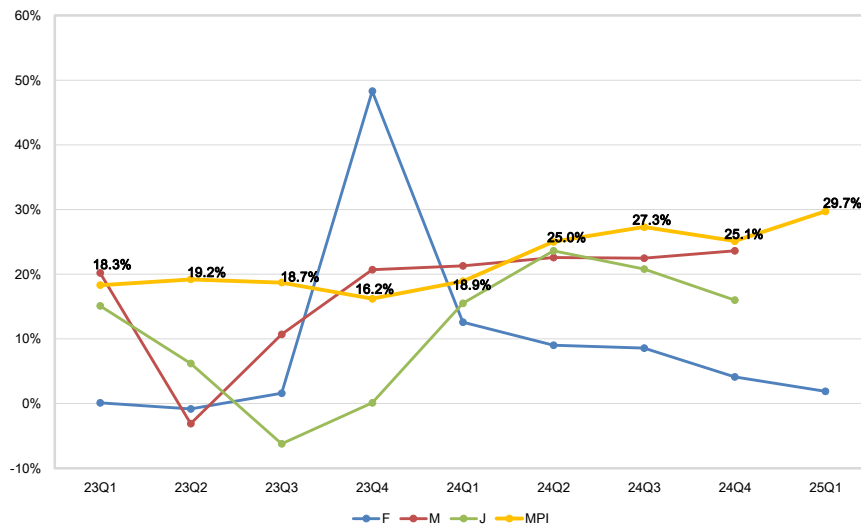
CPC及VPC成長趨勢



全球同業毛利率



全球同業營利率



MPI CORPORATION

READY FOR THE TEST™

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MPI Probe Card

Company Confidential C

Our Customer

The MPI is committing more than 800 customers globally to contribute to industrial development as well as providing testing industry advanced technology needs.



發光二極體事業部 (LED)

READY FOR THE TEST™

產品概覽



VEGA Line
Optical Sensing

AVIOR Line
Optical Communications

CAPELLA Line
LED/ Mini LED

GEMINI Line
Micro Display

➢ **High Power VCSEL Wafer Testing**
Wafer / Board Prober Development
Testing methodology Development

➢ **High Power VCSEL PKG Testing**
PKG Handler Development
Testing methodology Development

➢ **VCSEL / Photo-Detector Testing**
Wafer / Board Prober Development
Testing methodology Development

➢ **RF Character**
Wafer Level RF Testing Integration

➢ **SiPh Die/PKG Platform**
SiPh Handler Development

➢ **uLED Mass Production Methodology**
Wafer prober for large quantity die testing method

➢ **Panel testing platform development**
Panel / Panel in-process testing platform

發展計畫



Optical Sensing	Optical Communications	Micro Display
➢ Focus on Sensing VCSEL Testing ➢ Production Wafer Prober in Low Temperature ➢ High Power Measurement Tool and Technology Development ➢ Flip Chip Wafer VCSEL testing Solution ➢ Package / Hybrid Device testing tool	➢ Focus on VCSEL/Photodetector Testing ➢ Wafer Prober for Dark / Responsivity / Capacity measurement ➢ RF Measurement Capability Development ➢ SiPh package testing approaching	➢ Lab and production wafer testing tool development ➢ Contacting Accuracy Improvement ➢ Innovative testing methodology ➢ Optical measurement in production methodology

PA:與市場領導者合作

● Value Enhanced Product Lines 客戶價值導向的產品線規劃

MPI's experienced RD team comes across lighting and electrical fields with automation core technology that enables us to develop leading market solutions ie VCSEL & Micro LED.

● Solid Global Clientele 穩固的全球客戶群

MPI works closely with market leaders and international brand names for most advanced testing solutions.

● Continuous Product Innovation 持續的產品創新

Non stop RD investments helps MPI to provide high value added products that tackles clients' testing bottleneck.

MPICORPORATION

Thermal/AST

READY FOR THE TEST™

MPIThermal

Hot and Cold Air Flow
Environmental Temperature Test

-100°C  +300°C
ThermalAir Series
Temperature Testing Systems



Applications & Industry Segments



Semiconductor



Automotive



Aerospace



Telecommunications



Fiber Optic



Electronics



Sensors



Advanced Technology

Thermal:客戶導向

- **Innovational Temperature System** 創新的溫度測試系統

Ongoing R&D investments in platforms and improvements leads MPI to meet customer demands. Thermal systems have a number of patents to provide efficient energy saving products that helps clients to fulfill ESG responsibility.

- **Top Skillful RD Team** 頂尖優秀專業的研發團隊

MPI's thermal solutions are developed by industry veterans with over 100 years of combined experience.

- **Deep Cooperation with Leading Customers for Engineering and Production demand**

與世界領導級大廠深度合作, 提供工程及量產需求

Product application expands to automotive , 5G/RF communication , fiber optic , and sensing fields.

MPICORPORATION

READY FOR THE TEST™

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MPI Advanced Semiconductor Test

Engineering Probe Systems
and
RF Probe Products

50 – 300 mm

26 – 110 GHz

Applications & Industry Segments

Device Characterization	High Power	RF & mmW	Design Validation	Failure Analysis	Wafer Level Reliability	Silicon Photonics	Laser Cutter

AST:獨特的市場領導者

- **Unique Global Position** 全球獨特的市場地位

Combining Analytical probing solution and RF measurement core technology , MPI is top solution provider for full range hi-frequency response measurement.

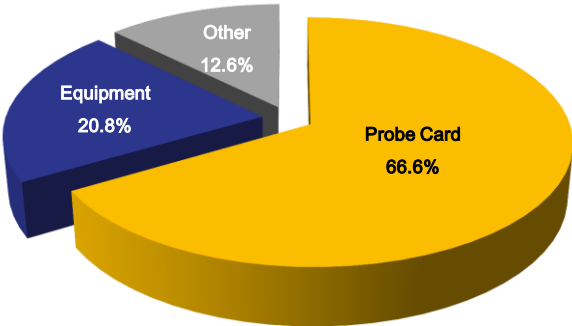
- **VOC Design** 客戶導向設計

Design based on Voice of the customer to full-fill customers' needs.

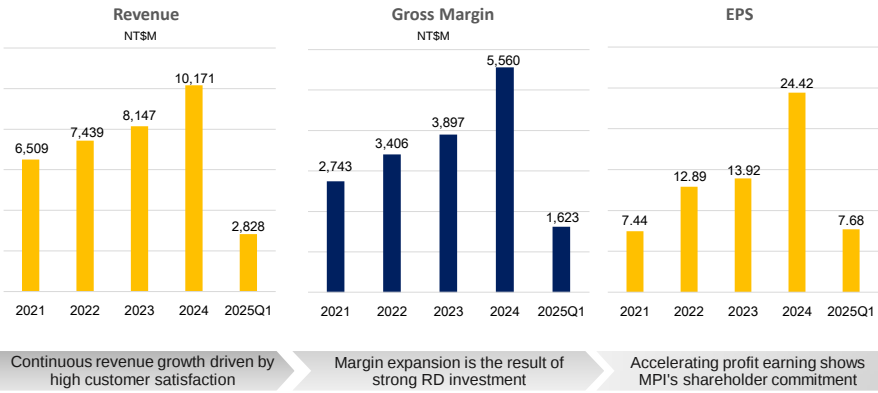
- **Complete Solution** 提供完整的解決方案

Various series of products to cover wide range applications include Device Modeling, RF & mmW, WLR, High-Power, Failure Analysis, Extreme temperature test ...etc.

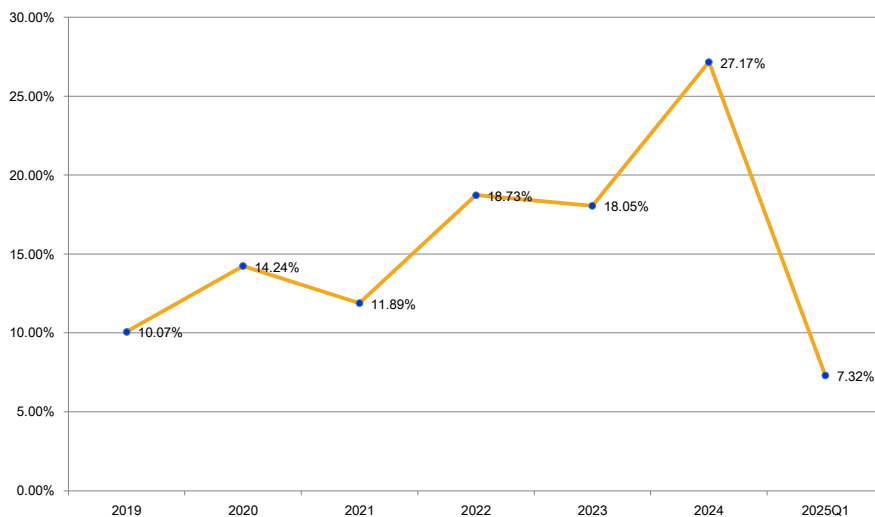
2025 Q1出貨分布



營業表現



股東權益報酬率



資產負債表

NT\$M	2025Q1		2024Q1	
Cash and Cash Equivalents	5,965	31%	2,546	20%
Fixed Assets	7,640	39%	5,669	45%
Total Assets	19,536	100%	12,565	100%
LT Debt	945	5%	1,453	12%
Shareholders' Equity	10,456	54%	8,206	65%
EBITDA	887	31%	482	23%

*EBITDA=operating income + depreciation & amortization expenses

綜合損益表

NT\$000	2025Q1		2024Q1	
Net Sales	2,828,698	100%	2,046,692	100%
Cost of Goods Sold	1,205,368	43%	1,020,800	50%
Gross Profit	1,623,330	57%	1,025,892	50%
Operating Expense	782,986	27%	639,117	32%
Operating Income	840,344	30%	386,775	18%
Investment Income & Others	47,380		95,592	
Net Income (after tax)	723,042	26%	392,927	19%
EPS (after tax)	7.68		4.18	

